

CT3231M/MFP

LOW POWER DRIVER/RECEIVER FOR MIL-STD-1553

(Note: "M" designates monolithic devices used internally.

Specifications also apply to the CT3231 and CT3231FP except as noted.)

FEATURES

- 1.5 Watt Total Hybrid Dissipation at 25% Transmitting Duty Cycle
- Meets MIL-STD-1553B
- TTL Compatible
- Meets MIL-STD-883 & MIL-M-38510
- Thick Film Hybrid Technology
- Driver/Receiver in a single Package for Space & Weight Savings
- Plug-In or Flat Pack Configuration
- Filtering on Receiver to Improve S/N Ratio of System

DRIVER DESCRIPTION

The CT3231M Driver section accepts complementary TTL Data at the input, and produces a 30 volt nominal peak-to-peak differential signal across a 140Ω load at the output. When coupled to the Data Bus with a 1:1 transformer, isolated on the Data Bus side with two 55.0 ohm fault isolation resistors, and loaded by two 70 ohm terminations plus additional receivers, the Data Bus signal produced is 7.2 volts nominal peak-to-peak.

When both "DATA" and "DATA" inputs are held low or both are held high, the driver output becomes a high impedance and is "removed" from the line. In addition, an overriding "INHIBIT" input provides for removal of the Driver output from the line. A logic "1" applied to the "INHIBIT" takes priority over the condition of the data inputs and disables the Driver. See Driver Logic Waveforms, Figure 3.

DATA and DATA inputs must be complementary waveforms, of 50% duty cycle average, with no gate delays between them. It is recommended that those inputs be driven from a "D" type flip-flop.

RECEIVER DESCRIPTION

The CT3231M Receiver section accepts Bi-Phase Differential data at the input and produces two TTL signals at the output. The outputs are "DATA" and "DATA", and represent positive and negative excursions (respectively) of the input beyond a predetermined threshold. See Receiver Logic Waveforms, Figure 2.

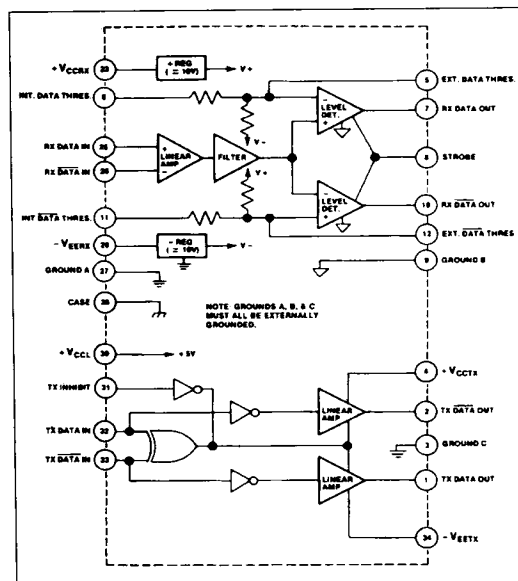


Figure 1: Functional Diagram and Pinouts

The positive and negative thresholds may be internally set by grounding the appropriate pins, or externally set with resistors. The pre-set internal thresholds will detect Data Bus signals exceeding 1 volt p-p and ignore signals less than 0.5 volt p-p when used with 1:1 transformer. (See Figure 4 for a suitable transformer and typical connection.)

A low level at the STROBE input inhibits the DATA and DATA outputs. If unused, a 2K ohm pull-up to +5V is recommended.

CT3231M SPECIFICATIONS

ABSOLUTE MAXIMUM RATINGS

| | |
|--|----------------------------------|
| Supply Voltage, Pin 4 or 23 | – 0.3 to + 18.0V |
| Supply Voltage, Pin 29 or 34 | + 0.3 to – 18.0V |
| Supply Voltage, Pin 30 | – 0.3 to + 7.0V |
| Logic Input Voltage, Pin 8, 31, 32, or 33 | – 0.3 to + 5.5V |
| Receiver Differential Input, Pin 25 to Pin 26 | ± 20 V (40 V p-p) |
| Receiver Input Voltage, Pin 25 or Pin 26 | ± 15 V |
| Driver Peak Output Current, Pin 1 or Pin 2 | ± 300 mA |
| Total Package Power Dissipation at (Ambient) $T_A = + 25^{\circ}\text{C}$ (Derate above $T_A = + 25^{\circ}\text{C}$ at 40 mW/ $^{\circ}\text{C}$) | 4.0 watts (Note 1) |
| Power Dissipation at Specified Case Temperatures | See Figure 5 |
| Operating Case Temperature Range (T_C) (See Figure 5 for limitations) | – 55 to + 125 $^{\circ}\text{C}$ |

ELECTRICAL CHARACTERISTICS, RECEIVER SECTION

| PARAMETER/CONDITION | | SYMBOL | MIN | TYP | MAX | UNIT |
|---|--|--|------------------------------|----------------|------------------------------|-------------------------------------|
| Power Supply Voltage Ranges (V_{CCL} is common to both Driver and Receiver) | | V_{CCRX} V_{EERX} V_{CCL} | + 11.75 – 11.75 + 4.75 | | + 15.75 – 15.75 + 5.25 | V V V |
| Supply Current (I_{CCL} includes Driver and Receiver Together) | | I_{CCRX} I_{EERX} I_{CCL} | | 25 30 35 | | mA mA mA |
| Differential Input Impedance | D.C. $f = 1\text{MHz}$ | R_{IN} Z_{IN} | 6K 4K | | | ohms ohms |
| Differential Voltage Range | | V_{IDR} | ± 20 | | | V peak |
| Input Common Mode Voltage Range | | V_{ICR} | ± 10 | | | V peak |
| Common Mode Rejection Ratio (From Point A, Fig. 4) | | CMRR | 40 | | | dB |
| Strobe Characteristics (Logic "0" inhibits Output) "0" Input Current (V strobe = 0.5 V) "1" Input Current (V strobe = 2.7 V) "0" Input Voltage "1" Input Voltage Strobe Delay (turn-on or turn-off) | | I_{IL} I_{IH} V_{IL} V_{IH} t_{SD} | 2.0 | 6 | – 4 400 0.7 | mA μA V V nS |
| Threshold Characteristics (Sinewave input, 100KHz to 1MHz) <i>Note: Threshold voltages are referred to the Input</i> Internal (Pin 6 & 11 grounded) External (Pin 6 & 11 open; threshold setting resistors from Pin 5 to ground & from Pin 12 to ground; R_{TH} Max = 10K ohms) | | V_{TH1} R_{TH}/V_{TH1} | 0.6 | 4000 | 0.9 | V p-p ohms/V p-p |
| Filter Characteristics (Pin 6 & 11 Grounded) (Sinewave input) | $f = 2\text{MHz}$ $f = 4\text{MHz}$ | V_{TH2} V_{TH3} | 0.8 4.2 | | 1.5 8.5 | V p-p V p-p |
| Output Characteristics, RX Data & Data "1" State ($I_{SOURCE} = - 0.4\text{ ma}$) Note 2 "0" State ($I_{SINK} = 4\text{ ma}$) Note 2 <i>Note: With Receiver input below threshold, both RX Data & RX Data outputs remain in "1" state.</i> Delay (average) from differential input zero crossings to RX Data & RX Data output 50% points. | | V_{OH} V_{OL} t_{DRX} | 2.5 | 3.3 190 | 0.5 450 | V V nS |

Note 1: Assumes unit in free air (natural convection cooling).

Note 2: For CT3231/CT3231FP ONLY, "1" state ($I_{SOURCE} = - 1\text{ ma}$), "0" state ($I_{SINK} = 10\text{ ma}$).

ELECTRICAL CHARACTERISTICS, DRIVER SECTION

| PARAMETER/CONDITION | SYMBOL | MIN | TYP | MAX | UNIT | |
|---|--|----------------------------|------------------|--|--|----------|
| Power Supply Voltage Ranges (See Receiver Section for V_{CCL}) | V_{CCTX} V_{EETX} | + 11.75 – 11.75 | | + 15.75 – 15.75 | V V | |
| Supply Current, "Standby" mode (see Receiver Section for I_{CCL}) (TX Inhibit high; or TX Data & TX Data both high or both low) | I_{CCTXS} I_{EETXS} | | 12 0 | Note 2 1 | mA mA | |
| Supply Current transmitting at 1MHz into a 35 ohm load at point A in Figure 4 (I_{CCL} limits do not change with mode of operation or duty cycle) | DUTY CYCLE | | | | | |
| | 25% | I_{CCX25} I_{EEX25} | Note 4 Note 3 | 45 35 | Note 2 Note 2 | mA mA |
| | 100% | I_{CCTX} I_{EETX} | Note 4 Note 3 | 150 135 | Note 2 Note 2 | mA mA |
| Input Characteristics, TX Data in or TX Data in "0" Input Current ($V_{IN} = 0.4$ V) "1" Input Current ($V_{IN} = 2.7$ V) "0" Input Voltage "1" Input Voltage | I_{ILD} I_{IHD} V_{ILD} V_{IHD} | | 2.0 | – 1.2 100 0.7 | mA μ A V V | |
| Inhibit Characteristic "0" Input Current ($V_{IN} = 0.4$ V) "1" Input Current ($V_{IN} = 2.7$ V) "0" Input Voltage "1" Input Voltage Delay from TX Inhibit (0→1) to inhibited output impedance Delay from TX Inhibit (1→0) to active output impedance Differential output noise, inhibit mode Differential output impedance (inhibited) at 1MHz | I_{ILI} I_{IHI} V_{ILI} V_{IHI} t_{DXOFF} t_{DXON} V_{NOI} Z_{OI} | 2.0 | 300 100 | – 0.8 50 0.7 400 250 10 | mA μ A V V nS nS mVp-p ohms | |
| Output Characteristics (Figure 3) Differential output level (140 ohm load) Differential Active output impedance at 1MHz Rise and Fall times (10% to 90% of p-p output) Output offset at point A in Fig. 4 (35 ohm load) 2.5 μ S after mid-bit crossing of the parity bit of the last word of a 660 μ S message Delay from 50% point of TX Data or TX Data input to zero crossing of differential output | V_O Z_{OA} t_r V_{OS} t_{DTX} | 26 100 | 30 4 150 | 35 300 | V p-p ohms nS mV peak nS | |

Note 2: Maximum supply currents for driver and receiver combined are included in power and thermal data table.

POWER AND THERMAL DATA, TOTAL HYBRID (DRIVER AND RECEIVER)

| PARAMETER/CONDITION | | SYMBOL | MIN | TYP | MAX | UNIT |
|---|------------------|--|------------------|----------------|----------------|----------------|
| Total Supply Current, "Standby" mode or transmitting at less than 1% duty cycle (e.g. 20 μS of transmission every 2mS or longer interval) | | I _{CCS} I _{EES} I _{CCL} | | 40 30 35 | 50 40 45 | mA mA mA |
| Total Supply Current transmitting at 1MHz into a 35 ohm load at point A in Figure 4 (I _{CCL} limits do not change with mode of operation or duty cycle) | DUTY CYCLE | I _{CC25} I _{EE25} | Note 4 Note 4 | 70 65 | 80 75 | mA mA |
| | 25% | | | | | |
| | 100% | I _{CC100} I _{EE100} | Note 4 Note 4 | 175 165 | 190 180 | mA mA |
| Power Dissipation of most critical (hottest) device in hybrid during continuous transmission (100% duty cycle) | SUPPLY VOLTAGE | | | | | |
| | ± 12 V ± 15 V | P _{C12} P _{C15} | Note 3 Note 3 | 300 450 | 400 600 | mW mW |
| Thermal Resistance, junction-to-case, of most critical device | | Θ _{JC} | | 80 | 100 | °C/W |
| Allowable transmitting duty cycle when case is held to + 100°C maximum | | Note 5 | | | 100 | % |
| Allowable transmitting duty cycle when case is held to + 125°C maximum | ± 12 V supplies | Note 5 | | | 80 | % |
| | ± 15 V supplies | Note 5 | | | 55 | % |

Note 3: Decreases linearly to zero at zero duty cycle.

Note 4: Decreases linearly to applicable "Standby" value at zero duty cycle.

Note 5: Based upon operating junction temperature of 160 $^{\circ}\text{C}$ for hottest device. For lower operating junction temperatures, reduce maximum duty cycle accordingly.

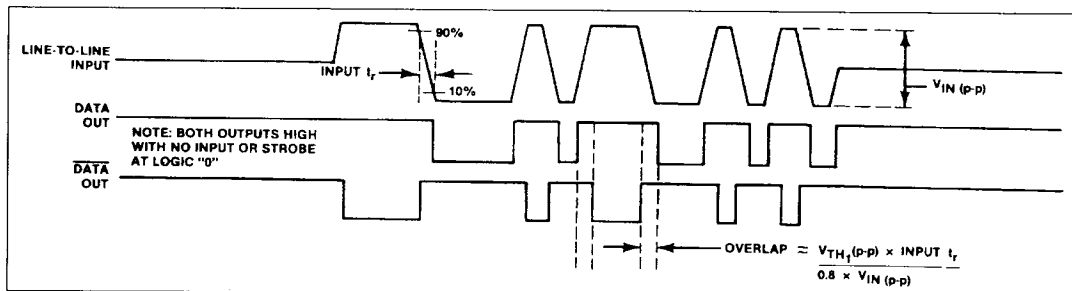


Figure 2: Receiver Logic Waveforms

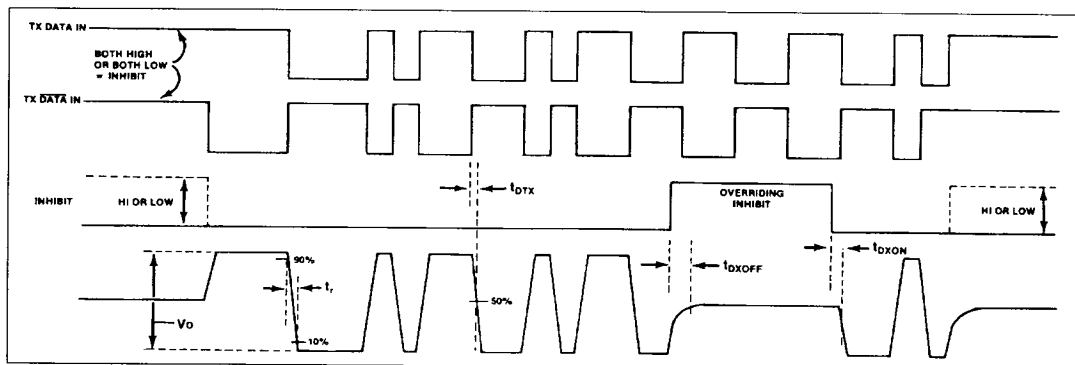


Figure 3: Driver Logic Waveforms

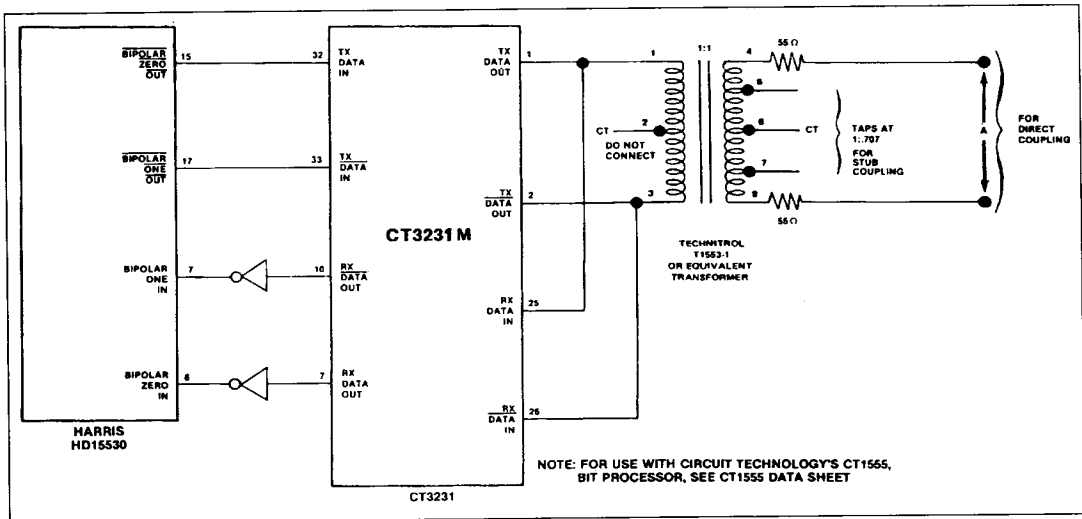


Figure 4: Typical Input/Output Connections

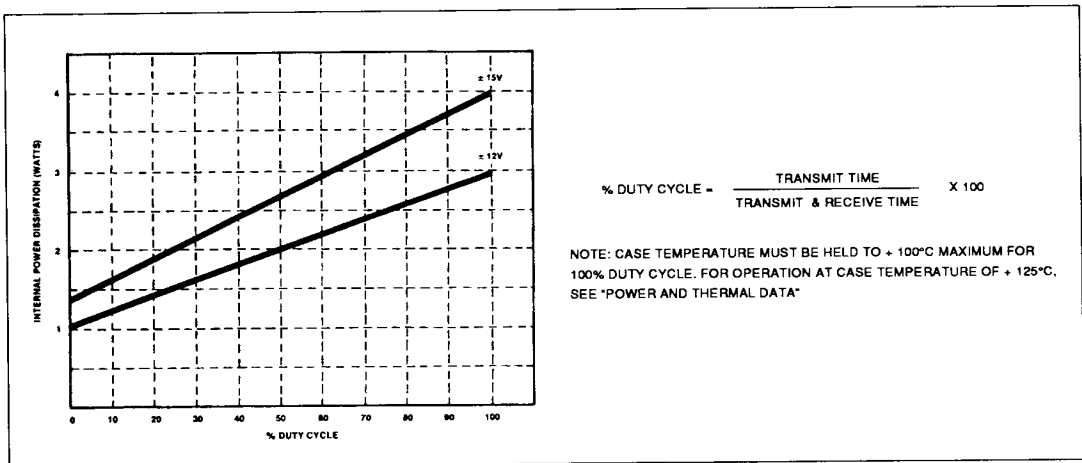


Figure 5: Typical Power Dissipation (Total Hybrid)

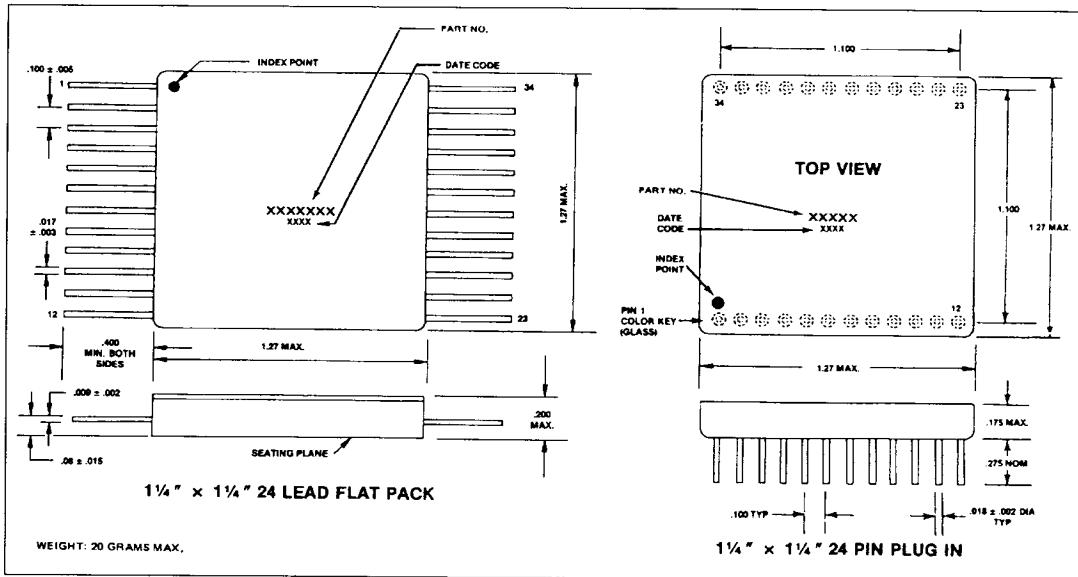


Figure 6. Package outline drawings